

INSTALLATION AND OPERATION

USER MANUAL

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UM680A

Automotive Grade GNSS High Precision RTK Positioning Module

Revision History

Version	Revision History	Date
R1.0	First release.	Aug. 2025



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Foreword

This document describes the information of the hardware, package, specification and the use of Unicore UM680A module.

This is only a draft version, for reference only.

Target Readers

This document applies to technicians who are familiar with GNSS receivers.



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1 Introduction

UM680A is an automotive-grade GNSS navigation and positioning module designed for intelligent driving field. It is based on the multi-system, dual-frequency and high-performance GNSS SoC - UC6580A, which conforms to the requirements of AEC-Q100, and the manufacturing process is in line with IATF 16949.

UM680A supports GPS/BeiDou/GLONASS*/Galileo/QZSS/NavIC* and L1+L5 frequency, providing RTK centimeter-level positioning function. It has two sub-models, UM680A-12 and UM680A-13 respectively, among which the working temperature of UM680A-13 supports 105 °C. See **Table 1-1** for more information.



Figure 1-1 UM680A High Precision Positioning Module

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^{*} Only supported by the specific firmware.



1.1 Key Specifications

Table 1-1 Technical Specifications

	UM680A-12	UM680A-13		
Products	Multi-system dual-frequency high	Multi-system dual-frequency high		
	precision RTK positioning module	precision RTK positioning module		
Illustration	UM680A P/N:23104140000XX SN:B4214800001	UM680A P/h:23104140000XX Sh:E4214800001		
Dimension	22.0 mm × 17.0 mm × 2.6 mm	22.0 mm × 17.0 mm × 2.6 mm		
Package	54 pin LGA	54 pin LGA		
Working Temperature	-40 °C to +85 °C	-40 °C to +105 °C		
Storage Temperature	-40 °C to +85 °C	-40 °C to +105 °C		
RF Input				
	GPS: L1C/A+L5	GPS: L1C/A+L5		
	BDS: B1I+B1C*+B2a	BDS: B1I+B1C*+B2a		
	Galileo: E1+E5a	Galileo: E1+E5a		
Frequency	GLONASS: G1*	GLONASS: G1*		
	NavIC: L5*	NavIC: L5*		
	QZSS: L1+L5	QZSS: L1+L5		
	SBAS	SBAS		
VSWR	≤ 2.5	≤ 2.5		
Input	50.0	50.0		
Impedance	50 Ω	50 Ω		
Antenna Gain	15 dB to 30 dB	15 dB to 30 dB		
Interface				
UART ¹	×2	×2		
I ² C ²	•	•		
SPI ³	•	•		
PPS	×1	×1		
EVENT	×1	×1		
	· ·	1		

^{*} Supported by the specific firmware.

¹ TTL; baud rate: 115200 to 921600 bps.

² Reserved; address: 7 bit; working mode: slave; supports 400 Kbps at most

³ UM680A has an SPIM and an SPIS, where SPIS is reserved (sharing pin 42 to 45 with UART and I2C). The maximum transfer rate of SPIS is 4 Mbps and that of SPIM is 16 Mbps.

	UM680A-12	UM680A-13		
Products	Multi-system dual-frequency high	Multi-system dual-frequency high		
1 1000013	precision RTK positioning module	precision RTK positioning module		
RESET_N	president that positioning module	prediction that postderning module		
NESET_IN	•			
RTK_STAT	•	•		
GNSS Antenna	×1	×1		
Performance				
	Cold start: 26 s	Cold start: 26 s		
TTFF	Hot start: 2 s	Hot start: 2 s		
	Reacquisition: 2 s	Reacquisition: 2 s		
Single Point	Horizontal: 1.5 m (open sky)	Horizontal: 1.5 m (open sky)		
Positioning	Vertical: 2.5 m (open sky)	Vertical: 2.5 m (open sky)		
Accuracy				
(RMS)				
RTK	Horizontal:	Horizontal:		
Positioning	1 cm + 1ppm (open sky)	1 cm + 1ppm (open sky)		
Accuracy	Vertical:	Vertical:		
(RMS)	2 cm + 1ppm (open sky)	2 cm + 1ppm (open sky)		
Velocity				
Accuracy	0.05 m/s	0.05 m/s		
(RMS) ⁴				
	Tracking: -162 dbm	Tracking: -162 dbm		
Sensitivity	Cold start: -147 dbm	Cold start: -147 dbm		
Sensitivity	Hot start: -157 dbm	Hot start: -156 dbm		
	Reacquisition: -158 dbm	Reacquisition: -158 dbm		
Data Update	1 Hz/5 Hz/10 Hz	1 Hz/5 Hz/10 Hz		
Rate				
1PPS Accuracy	20 ns	20 ns		
(RMS)	20110	20110		
	NMEA 0183	NMEA 0183		
Data Format	Unicore Protocol	Unicore Protocol		
	RTCM	RTCM		
Electrical Specifi	cations			
Voltage	2.7 V to 3.6 V, Typ.: 3.3 V	2.7 V to 3.6 V, Typ.: 3.3 V		
LNA Feed	0.7.14- 0.0.1 100 1	0.7.74-2.0.74 100 1		
Power	2.7 V to 3.3 V, <100 mA	2.7 V to 3.3 V, <100 mA		
Power	240 mW	240 mW		
Consumption	Z-TO IIIIV	240 1111		

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⁴ 68% at 30 m/s for dynamic operation, open sky



Environmental Specifications					
Humidity	95% No condensation	95% No condensation			
Vibration	GB/T 28046.3; ISO 16750.3	GB/T 28046.3; ISO 16750.3			
Shock	GB/T 28046.3; ISO 16750.3	GB/T 28046.3; ISO 16750.3			

1.2 Block Diagram

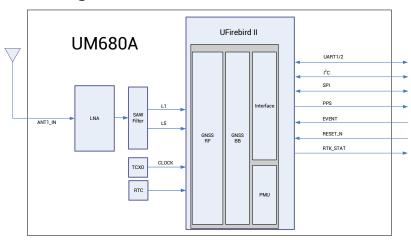


Figure 1-2 UM680A Block Diagram

1. RF Part

The receiver gets filtered and enhanced GNSS signals from the antenna via a coaxial cable. The RF part converts the RF input signals into the IF signals, and converts IF analog signals into digital signals required for UFirebird II chip.

2. UFirebird II SoC (UC6580A)

UFirebird II is the new generation RF-baseband and high-precision algorithm integrated SoC developed by Unicore. It adopts 22 nm technology and low power consumption design, supporting multi-path mitigation, anti-jamming and high precision GNSS joint positioning. The chip is especially suitable for the application scenarios which are sensitive to power and size.

3. Interfaces

UM680A has interfaces such as UART, I²C*, SPI*, PPS, EVENT, RTK_STAT and RESET_N.

There are two UARTs. UART1 is the master serial port, supporting data transmission and firmware upgrade, and the I/O signal type is LVTTL. The baud rate can be configured by users. UART2 is a backup and only supports data transmission. It is unavailable for firmware upgrade.

^{*} I2C and SPI are reserved interfaces.

2 Hardware

2.1 Pin Definition

See Figure 2-1 for the definition of UM680A-12/UM680A-13.

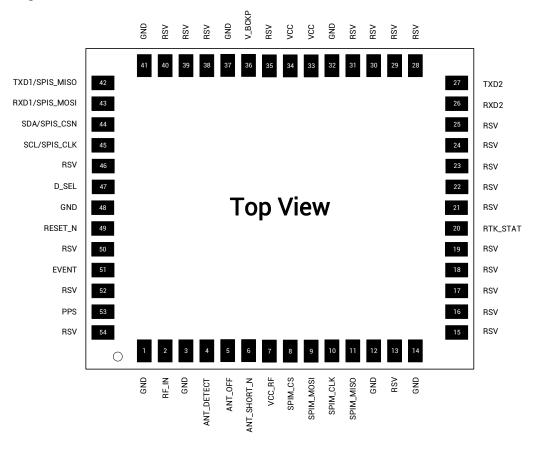


Figure 2-1 UM680A-12/UM680A-13 Pin Definition

Table 2-1 UM680A-12/UM680A-13 Pin Definition

No.	Pin	I/O	Description
1	GND	_	Ground
2	RF_IN	I	GNSS antenna signal input
3	GND	_	Ground
4	ANT_DETECT	I	Active antenna detection. Active high. High = antenna detected; Low = antenna not detected.
5	ANT_OFF	0	Disable external antenna power supply. Active high. High = disable external antenna; Low = enable external antenna.



No.	Pin	I/O	Description
			Active antenna short detection. Active low.
6	ANT_SHORT_N	ļ	Low = antenna short circuit;
			High = antenna power status normal.
7	VCC_RF⁵	0	Antenna feed output
8	SPIM_CS	_	Chip select pin for SPI master
9	SPIM_MOSI	0	Master Out / Slave In. This pin is used to transmit data in master mode.
10	SPIM_CLK	_	Clock input pin for SPI master
11	SPIM_MISO	I	Master In / Slave Out. This pin is used to receive data in master mode.
12	GND	_	Ground
13	RSV	_	Reserved, leave floating.
14	GND	_	Ground
15	RSV	_	Reserved, leave floating.
16	RSV	_	Reserved, leave floating.
17	RSV	_	Reserved, leave floating.
18	RSV	_	Reserved, leave floating.
19	RSV	_	Reserved, leave floating.
			RTK positioning indicator, active high.
20	RTK_STAT	0	High = RTK fix;
			Low = other status.
21	RSV	_	Reserved, leave floating.
22	RSV	_	Reserved, leave floating.
23	RSV	-	Reserved, leave floating.
24	RSV	_	Reserved, leave floating.
25	RSV	_	Reserved, leave floating.
26	RXD2	I	UART2 input, LVTTL level
27	TXD2	0	UART2 output, LVTTL level
28	RSV	_	Reserved, leave floating.
29	RSV	_	Reserved, leave floating.
30	RSV	_	Reserved, leave floating.

_

⁵ Not recommended to use VCC_RF to feed the antenna (VCC_RF is not optimized for the anti-lightning strike and anti-surge due to the compact size of the module).

31 RSV — Reserved, leave floating. 32 GND — Ground	
32 GND — Ground	
32 GIVUIIU	
33 VCC I Power supply (+3.3 V)	
34 VCC I Power supply (+3.3 V)	
35 RSV — Reserved, leave floating.	
When the main power supply V_BCKP supplies power to RTG register. Supply voltage: 2.0 V the working current is less that 25 °C. If you do not use the hoconnect V_BCKP to VCC or a spower source. Do NOT connect or leave it floating.	C and relevant to 3.6 V, and an 10 µA at at start function, standalone
37 GND – Ground	
38 RSV — Reserved, leave floating.	
39 RSV – Reserved, leave floating.	
40 RSV – Reserved, leave floating.	
41 GND – Ground	
UART1 output (D_SEL=VCC or 42 TXD1/SPIS_MISO O Master In/Slave Out of SPI sla (D_SEL=GND)	5,
UART1 input (D_SEL=VCC or fl 43 RXD1/SPIS_MOSI I Master Out/Slave In of SPI sla (D_SEL=GND)	5 /
44 SDA/SPIS_CSN I SPI slave chip select (D_SEL=0	5,
45 SCL/SPIS_CLK I I ² C clock (D_SEL=VCC or floati SPI slave clock (D_SEL=GND)	ing);
46 RSV — Reserved	
Interface select pin; Use pin 42 to 45 as a SPI slave = GND, as UART1 and I ² C When or floating	
48 GND – Ground	
49 RESET_N I System reset; active low; the active time should be no le	ess than 5 ms
50 RSV — Reserved, leave floating.	



No.	Pin	I/O	Description
51	EVENT	I	Event mark input with adjustable frequency and polarity
52	RSV	_	Reserved, leave floating.
53	PPS	0	Pulse per second with adjustable pulse width and polarity
54	RSV	_	Reserved, leave floating.

2.2 Electrical Specifications

2.2.1 Absolute Maximum Ratings

Table 2-2 Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Remark
Power Supply	VCC	-0.2	3.6	V	
Backup Battery	V_BCKP	-0.2	3.6	V	
Digital Pin Voltage		-0.2	3.6	V	
Antenna RF Input Power	RF_IN	-	-3	dBm	
Storage Temperature	T _{STG}	-40	+85	°C	UM680A-12
Storage Temperature	T _{STG}	-40	+105	°C	UM680A-13
Reflow Soldering	T _{SLDR}	_	+245	°C	
Temperature	I SLDR	-	TZ4 0	U	

2.2.2 Operational Conditions

Table 2-3 Operational Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Power Supply	VCC	2.7	3.3	3.6	٧	
VCC Ripple	Vp-p			50	mV	
Peak Current	Ісср			200	mA	VCC = 3.0 V
Average Tracking Current ⁶	I _{ACQ}	70	80	100	mA	VCC = 3.0 V
Low Level Input Voltage	V_{IL}	-0.3		0.2 × VCC	V	
High Level Input Voltage	V _{IH}	0.7 × VCC		3.6	V	
Low Level Output Voltage	V _{OL}	0		0.4	V	I _{out} = -2 mA
High Level Output Voltage	V _{OH}	VCC - 0.4		Vcc	V	I _{out} = 2 mA
Antenna Gain	G _{ANT}	15	20	30	dB	

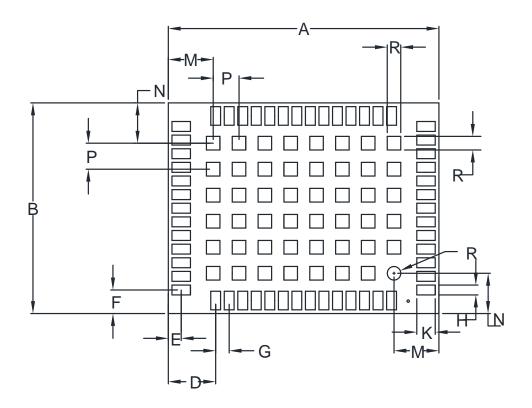
⁶ Since the product has capacitors inside, inrush current occurs during power-on. You should evaluate in the actual environment in order to check the effect of the supply voltage drop caused by inrush current in the system.



2.3 Dimensions

Table 2-4 Dimensions

Symbol	Min. (mm)	Typ. (mm)	Max. (mm)
Α	21.80	22.00	22.50
В	16.80	17.00	17.50
С	2.40	2.60	2.80
D	3.75	3.85	3.95
E	0.95	1.05	1.15
F	1.80	1.90	2.00
G	1.00	1.10	1.20
Н	0.70	0.80	0.90
K	1.40	1.50	1.60
М	3.55	3.65	3.75
N	3.15	3.25	3.35
Р	2.00	2.10	2.20
R	1.00	1.10	1.20
X	0.72	0.82	0.92



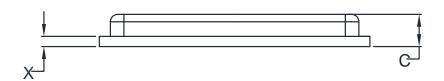


Figure 2-2 UM680A Mechanical Dimensions



3 Hardware Design

Recommended Minimal Design 3.1

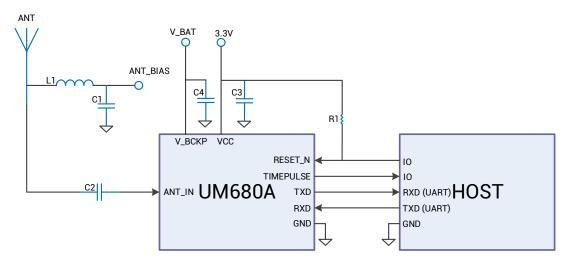


Figure 3-1 UM680A Recommended Minimal Design

Remarks:

- L1: 68 nH RF inductor in 0603 package is recommended
- C1: 100 nF + 100 pF capacitors connected in parallel is recommended
- C2: 100 pF capacitor is recommended
- C3: Several 10 µF + 100 nF capacitors connected in parallel is recommended
- C4: 100 nF capacitor is recommended
- R1: 10 k Ω resistor is recommended, pull up

Antenna Feed Design 3.2

UM680A just supports feeding the antennal from the outside of the module rather than the inside. It is recommended to use devices with high power and that can withstand high voltage. Gas discharge tube, varistor, TVS tube and other high-power protective devices may also be used in the power supply circuit to further protect the module from lighting strike and surge.

⚠ If the antenna feed supply ANT_BIAS and the module's main supply VCC use the same power rail, the ESD, surge and overvoltage from the antenna will have an effect on VCC, which may cause damage to the module. Therefore, it is recommended to design an independent power rail for the ANT_BIAS to reduce the possibility of module damage.

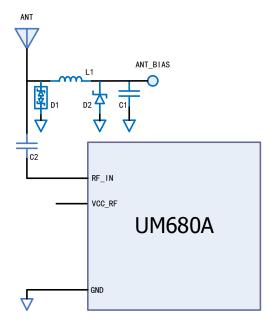


Figure 3-2 UM680A External Antenna Feed Reference Circuit

Remarks:

- L1: feed inductor, 68nH RF inductor in 0603 package is recommended;
- C1: decoupling capacitor, it is recommended to connect two capacitors of 100nF/100pF in parallel;
- C2: DC blocking capacitor, recommended 100pF capacitor;
- Not recommended to take VCC_RF as ANT_BIAS to feed the antenna (VCC_RF is not optimized for the anti-lightning strike and anti-surge due to the compact size of the module)
- D1: ESD diode, choose the ESD protection device that supports high frequency signals (above 2000 MHz)
- D2: TVS diode, choose the TVS diode with appropriate clamping specification according to the requirement of feed voltage and antenna voltage



3.3 Antenna Detection Design

UM680A supports the detection of open circuit and short circuit, and it will cut the antenna feed supply when a short circuit happens. The antenna detection circuit is connected to the pins of ANT_DETECT, ANT_SHORT_N and ANT_OFF, the voltage level of which can be used to judge the antenna status.

Refer to UM680A Hardware Reference Design for the details of the antenna detection circuit.

3.4 Power-on and Power-off

VCC

- The VCC initial level when power-on should be less than 0.4 V.
- The VCC ramp when power-on should be monotonic, without plateaus.
- The voltages of undershoot and ringing should be within 5% VCC.
- VCC power-on waveform: The time interval from 10% rising to 90% must be within 100 µs to 10 ms.
- Power-on time interval: The time interval between the power-off (VCC < 0.4 V) to the next power-on must be larger than 500 ms.

V_BCKP

- The V_BCKP initial level when power-on should be less than 0.4 V.
- The V_BCKP ramp when power-on should be monotonic, without plateaus.
- The voltages of undershoot and ringing should be within 5% V_BCKP.
- V_BCKP power-on waveform: The time interval from 10% rising to 90% must be within 100 μs to 10 ms.
- Power-on time interval: The time interval between the power-off (V_BCKP < 0.4 V) to the next power-on must be larger than 500 ms.

3.5 Grounding and Heat Dissipation

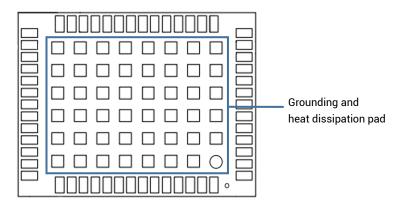


Figure 3-3 Grounding and Heat Dissipation Pad

The 48 pads in the rectangle in **Figure 3-3** are for grounding and heat dissipation. In the PCB design, it is recommended to connect them to a large sized ground to strengthen the heat dissipation.



3.6 Recommended Footprint on the PCB

The dimensions of UM680A's footprint on the PCB is recommended to be the same as that of the module's pads, as shown in **Figure 3-4 Recommended Footprint**. For more information about the module's dimensions, see **2.3 Dimensions**.

- For the convenience of hardware testing and debugging, proper test points can be added for the functional pins of the module.
- The dimensions of PCB pads can be optimized according to the specific production process to ensure manufacturability and reliability.

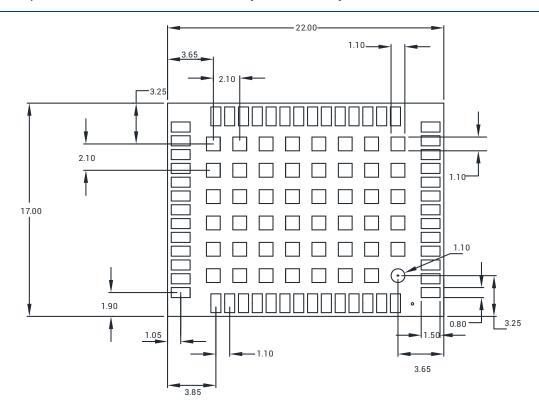


Figure 3-4 Recommended Footprint (Unit: mm)

4 Production Requirements

4.1 Clean



Do NOT use alcohol or other organic solvents to clean the module, or it may lead to flux residues entering into the shielding shell, causing mildew and other problems.

4.2 Soldering

Recommended soldering temperature curve is as follows:

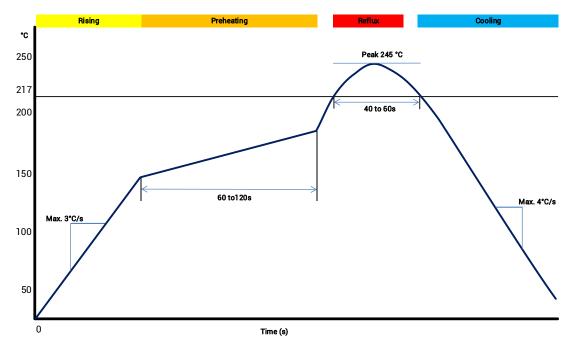


Figure 4-1 Soldering Temperature (Lead-free)

Temperature Rising Stage

Rising slope: Max. 3 °C/s

Rising temperature range: 50 °C to 150 °C

Preheating Stage

Preheating time: 60 s to 120 s

Preheating temperature range: 150 °C to 180 °C

Reflux Stage

• Over melting temperature (217 °C) time: 40 s to 60 s

Peak temperature for soldering: no higher than 245 °C



Cooling Stage

Cooling slope: Max. 4 °C/s



In order to prevent falling off during soldering of the module, do not solder it on the back of the board during design, that is, better not go through soldering cycle twice.

The setting of soldering temperature depends on many factors of the factory, such as board type, solder paste type, solder paste thickness, etc. Please also refer to the relevant IPC standards and indicators of solder paste.

4.3 Stencil

The apertures in the stencil need to meet the customer's own design requirements and inspection specifications. The thickness of the stencil is recommended to be 0.15 mm (not less than 0.12 mm).

The design of the stencil can be optimized according to the specific production process to ensure manufacturability and reliability.

5 Packaging

5.1 Label Description



Figure 5-1 Label Description

5.2 Ordering Information

Product Model	Sub-model	Description
UM680A	12	Automotive grade;
		dual-frequency RTK positioning module;
		operating temperature: -40 °C to +85 °C; supporting firmware upgrade;
		22 mm x 17 mm; 250 pieces/reel
	13	Automotive grade;
		dual-frequency RTK positioning module; operating temperature: -40 °C to +105 °C;
		supporting firmware upgrade;
		22 mm x 17 mm; 250 pieces/reel



5.3 Product Packaging

The UM680A module uses carrier tape and reel (suitable for mainstream surface mount devices), packaged in vacuum-sealed aluminum foil antistatic bags, with a desiccant inside to prevent moisture. When using reflow soldering process to solder modules, please strictly comply with IPC standard to conduct humidity control. As packaging materials such as the carrier tape can only withstand the temperature of 55 °C, modules shall be removed from the package during baking.

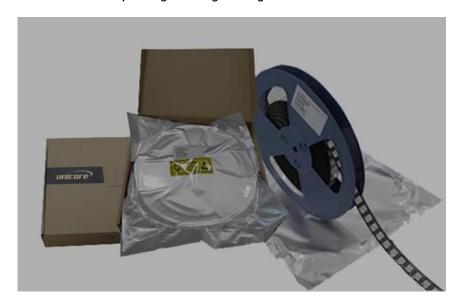
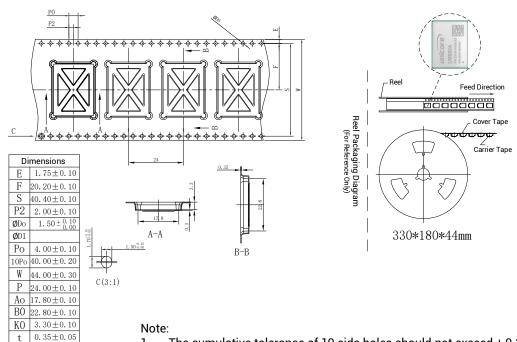


Figure 5-2 UM680A Package



- The cumulative tolerance of 10 side holes should not exceed \pm 0.2 mm. 1.
- Material of the tape: Black antistatic PS (surface impedance 105-1011) 2. (surface static voltage <100 V), thickness: 0.35 mm.
- 3. Total length of the 13-inch reel package: 6.816 m (Length of the first part of empty packets: 0.408 m, length of packets containing modules: 6 m, length of the last part of empty packets: 0.408 m).
- Total number of packets in the 13-inch reel package: 284 (Number of the 4. first part of empty packets: 17; actual number of modules in the packets: 250; number of the last part of empty packets: 17).
- All dimension designs are in accordance with EIA-481-C-2003. 5.
- The maximum bending degree of the carrier tape within the length of 250 mm should not exceed 1 mm (see the figure below).

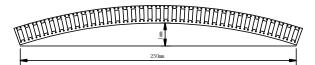


Figure 5-3 UM680A Reel Package Diagram



Table 5-1 Package Description

Item	Description		
Module Number	250 pieces/reel		
Reel Size	Tray: 13"		
	External diameter: 330 ± 2 mm		
	Internal diameter: 180 ± 2 mm		
	Width: 44.5 ± 0.5 mm		
	Thickness: 2.0 ± 0.2 mm		
Carrier Tape	Space between (center-to-center distance): 24 mm		

Before surface mounting, make sure that the color of the 30% circle on the HUMIDITY INDICATOR is blue (see Figure 5-4). If the color of the 20% circle is pink and the color of the 30% circle is lavender (see Figure 5-5), you must bake the module until it turns to blue. The UM680A is rated at MSL level 3. Refer to the relevant IPC/JEDEC J-STD-033 standards for the package and operation requirements. Users may access to the website www.jedec.org to get more information.

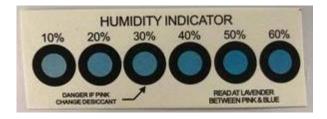


Figure 5-4 Normal Humidity Indication

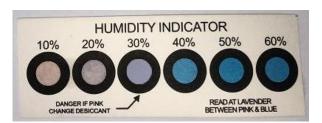


Figure 5-5 Abnormal Humidity Indication

The shelf life of the UM680A module packaged in vacuum-sealed aluminum foil antistatic bags is one year.

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